

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

EPAS ID: PAT5295360

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
HIROSHI KATSUMOTO	12/20/2018
TARO YOSHIDA	12/20/2018
HIDEKAZU FUNAKOSHI	12/20/2018
YUKINORI NAKAGAWA	12/20/2018
YASUYUKI SONODA	12/20/2018
YASUMASA NAGASAKI	12/20/2018
RECEIVING PARTY DATA	
Name:	SAMSUNG ELECTRONICS CO., LTD.
Street Address:	129, SAMSUNG-RO, YEONGTONG-GU
City:	SUWON-SI, GYEONGGI-DO
State/Country:	KOREA, REPUBLIC OF
Postal Code:	16677
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	16228355
CORRESPONDENCE DATA	
Fax Number:	(972)628-3616
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	972-628-3600
Email:	patents@munckwilson.com
Correspondent Name:	DOCKET CLERK
Address Line 1:	P.O. DRAWER 800889
Address Line 4:	DALLAS, TEXAS 75380
ATTORNEY DOCKET NUMBER:	PSD18-0167-US0
NAME OF SUBMITTER:	JACOB L. LACOMBE
SIGNATURE:	/Jacob L. LaCombe, Reg. #63,036/
DATE SIGNED:	12/20/2018
Total Attachments: 2	

source=PSD18-0167-US0 (SAMS14-80167) Assignment (partially signed)#page1.tif
source=PSD18-0167-US0 (SAMS14-80167) Assignment (partially signed)#page2.tif

ASSIGNMENT

WHEREAS, We, **Tomonori Ueno**, resident of Yokohama-shi, Kanagawa, Japan, **Hiroshi Katsumoto**, resident of Yokohama-shi, Kanagawa, Japan, **Taro Yoshida**, resident of Yokohama-shi, Kanagawa, Japan, **Hidekazu Funakoshi**, resident of Yokohama-shi, Kanagawa, Japan, **Yukinori Nakagawa**, resident of Yokohama-shi, Kanagawa, Japan, **Yasuyuki Sonoda**, resident of Yokohama-shi, Kanagawa, Japan, **Masaki Oshige**, resident of Yokohama-shi, Kanagawa, Japan, and **Yasumasa Nagasaki**, resident of Yokohama-shi, Kanagawa, Japan, have invented certain new and useful improvements in a **"MOTOR AND WASHING MACHINE HAVING THE SAME"** disclosed in an application for United States Letters Patent (Application Serial No. 16/228,355, filed on December 20, 2018), said application having been executed concurrently herewith;

WHEREAS, **SAMSUNG ELECTRONICS CO., LTD.**, a corporation organized under the laws of the Republic of Korea, having a place of business at 129, Samsung-ro, Yeongtong-gu, Suwon-si, Gyeonggi-do, 16677, Republic of Korea (hereinafter referred to as "ASSIGNEE"), is desirous of acquiring our entire right, title and interest in and to the invention, and in and to the said application and any Letters Patent that may issue thereon;

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, we do hereby sell, assign and transfer unto said ASSIGNEE, its successors, assigns and legal representatives, the full and exclusive right, title and interest in and to said invention and in and to said application and all patents which may be granted therefor, and all divisions, reissues, substitutions, continuations, continuations-in-part and extensions thereof; We authorize William A. Munck of Munck Wilson Mandala, LLP to insert in the parenthesis above the application number and filing date of said application when known; and we hereby authorize and request the Commissioner of Patents and Trademarks to issue all patents for said invention, or patents resulting therefrom, insofar as our interest is concerned, to the said ASSIGNEE of our entire right, title and interest.

We also hereby sell and assign to said ASSIGNEE, its successors, assigns and legal representatives the full and exclusive rights, title and interest to the invention disclosed in said application throughout the world, including the right to file applications and obtain patents, utility models, industrial models and designs for said invention in its own name throughout the world including all rights of priority, all rights to publish cautionary notices reserving ownership of said invention and all rights to register said invention in appropriate registries; and we further agree to execute any and all powers of attorney, applications, assignments, declarations, affidavits, and any other papers in connection therewith necessary to perfect such rights, title and interest in ASSIGNEE, its successors, assigns and legal representatives.

We hereby further agree that we will communicate to said ASSIGNEE, or to its successors, assigns and legal representatives, any facts known to us respecting any improvements; and, at the

expense of said ASSIGNEE, to testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, continuation-in-part, reissue and substitute applications, and make all lawful oaths, and generally do everything possible to vest title in said ASSIGNEE and to aid said ASSIGNEE, its successors, assigns and legal representatives to obtain and enforce proper protection for said invention in all countries.

Date:

Tomonori Ueno

Date: December 20, 2018

Hiroshi Katsumoto
Hiroshi Katsumoto

Date: December 20, 2018

Taro Yoshida
Taro Yoshida

Date: December 20, 2018

Hidekazu Funakoshi
Hidekazu Funakoshi

Date: December 20, 2018

Yukinori Nakagawa
Yukinori Nakagawa

Date: December 20, 2018

Yasuyuki Sonoda
Yasuyuki Sonoda

Date:

Masaki Oshige

Date: December 20, 2018

Yasumasa Nagasaki
Yasumasa Nagasaki